

WLAN7207H

Active

Fully qualified to meet NXP quality and reliability requirements. Available for production quantity orders.

Features

Wi-Fi 6 and Bluetooth Front-End IC, 2.4 GHz.

Product Summary

Package

HWFLGA18

HWFLGA18, thermal enhanced very-very thin fine-pitched land grid array package, 18 terminals, 0.4 mm pitch, 2.4 mm x 2 mm x 0.64 mm body.



Buy Options Operating Features Environmental Quality Shipping

Buy Options

WLAN7207HY

12NC: 935420135518

Active

Packing: REEL-Reel 13" Q1/T1 in Drypack

Min. Package Quantity: 10000 Min. Order Quantity: 10000

Lead Time: 26

> Available Distributors: WLAN7207HY

Operating Features

Parameter	Value
Security Status	COMPANY PUBLIC
Description	Wi-Fi 6 and Bluetooth Front-End IC, 2.4 GHz

Parameter	Value
Number of pins	18
Package Style	LGA

Environmental

Part/12NC	PbFree	EU RoHS	Halogen Free	RHF Indicator	REACH SVHC	Weight (mg)
WLAN7207HY (935420135518)	Yes	Yes Certificate Of Analysis (CoA)	Yes	D	REACH SVHC	8.31654

Quality

Part/12NC	Safe Assure Functional Safety	Moisture Sensitivity Level (MSL)		Peak Package Body Temperature (PPT) (C°)	
		Lead Soldering	Lead Free Soldering	Lead Soldering	Lead Free Soldering
WLAN7207HY (935420135518)	No	3	3	240	260

Shipping

Part/12NC	Harmonized Tariff (US) Disclaimer
WLAN7207HY (935420135518)	854233



